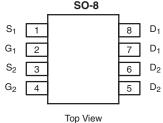
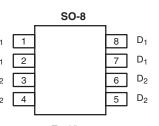


**Vishay Siliconix** 

## **Dual N-Channel 30-V (D-S) MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}$ (Ω) $I_{D}$ (A) <sup>a,</sup>		Q <sub>g</sub> (Typ.)			
	0.016 at V <sub>GS</sub> = 10 V	8				
30	0.018 at V <sub>GS</sub> = 4.5 V	8	19			
	0.024 at V <sub>GS</sub> = 2.5 V	8				



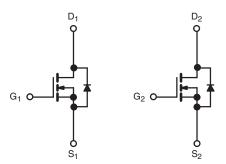


#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 ٠ Definition
- TrenchFET<sup>®</sup> Power MOSFET •
- 100 % R<sub>g</sub> and UIS tested
- Compliant to RoHS Directive 2002/95/EC ٠



RoHS COMPLIANT HALOGEN FREE Available



Ordering Information: Si4922BDY-T1-E3 (Lead (Pb)-free) Si4922BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_{\mu}$	$x = 25 \ ^{\circ}C$ , unless other	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	30	V	
Gate-Source Voltage	V <sub>GS</sub>	± 12	v	
	T <sub>C</sub> = 25 °C		8 <sup>e</sup>	
Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C		8 <sup>e</sup>	
$Continuous Drain Current (1) = 150^{\circ} C)$	T <sub>A</sub> = 25 °C		8 <sup>b, c, e</sup>	
	T <sub>A</sub> = 70 °C		6.6 <sup>b, c</sup>	
Pulsed Drain Current (10 µs Pulse Width)	I <sub>DM</sub>	35	A	
Source-Drain Current Diode Current	T <sub>C</sub> = 25 °C		2.5	
Source-Drain Current Diode Current	T <sub>A</sub> = 25 °C	Is	1.7 <sup>b, c</sup>	
Pulsed Sorce-Drain Current	I <sub>SM</sub>	35		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	15	
Single-Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	11.2	mJ
	T <sub>C</sub> = 25 °C		3.1	
Movimum Douver Dissinction	T <sub>C</sub> = 70 °C	P <sub>D</sub>	2	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	'D	2 <sup>b, c</sup>	vv
	T <sub>A</sub> = 70 °C	1	1.28 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 50 to 150	°C	

THERMAL RESISTANCE RATINGS						
		Li				
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	50	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	30	40	C/VV	

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 110 °C/W.

e. Package Limited.

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Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		35		m\//°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		- 4.6		mV/°C	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	0.6		1.8	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			100	nA	
	1		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$		1	μA	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 10 V$	20			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A		0.0135	0.016		
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		0.0145	0.018	Ω	
		$V_{GS} = 2.5 \text{ V}, I_D = 5 \text{ A}$	0.018 0.024		0.024	-	
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		30		S	
Dynamic <sup>a</sup>							
Input Capacitance	C <sub>iss</sub>			2070			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		255		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			135		1 .	
Total Gate Charge	Q <sub>g</sub> Q <sub>qs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		41	62		
				19	29	nC	
Gate-Source Charge		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$		3.5			
Gate-Drain Charge	Q <sub>gd</sub>			3.7		-	
Gate Resistance	R <sub>q</sub>	f = 1 MHz		1.8	3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			7	14		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3 $\Omega$		27	41	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$		31	47	-	
Fall Time	t <sub>f</sub>			8	15		
Turn-On Delay Time	t <sub>d(on)</sub>			13	25	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3 $\Omega$		53	80	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		68	102		
Fall Time	t <sub>f</sub>			54	81		
Drain-Source Body Diode Characteristic	S		1		1		
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			2.5		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	-			35	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1.7 A		0.77	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	-		32	48	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			21	32	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = 1.7 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		13			
Reverse Recovery Rise Time	t <sub>b</sub>			19		ns	

Notes:

a. Guaranteed by design, not subject to production testing.

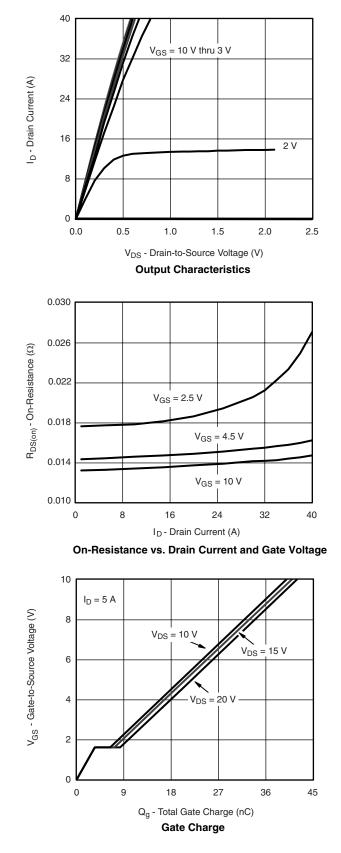
b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

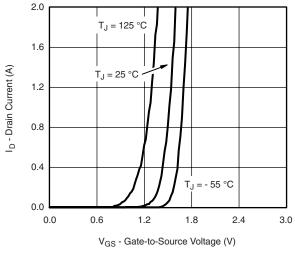
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



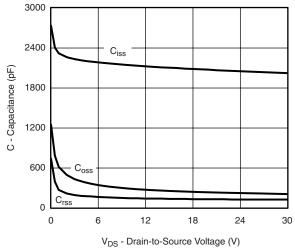
Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

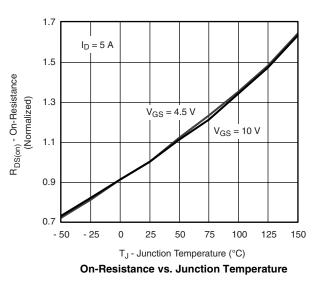


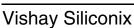


**Transfer Characteristics** 



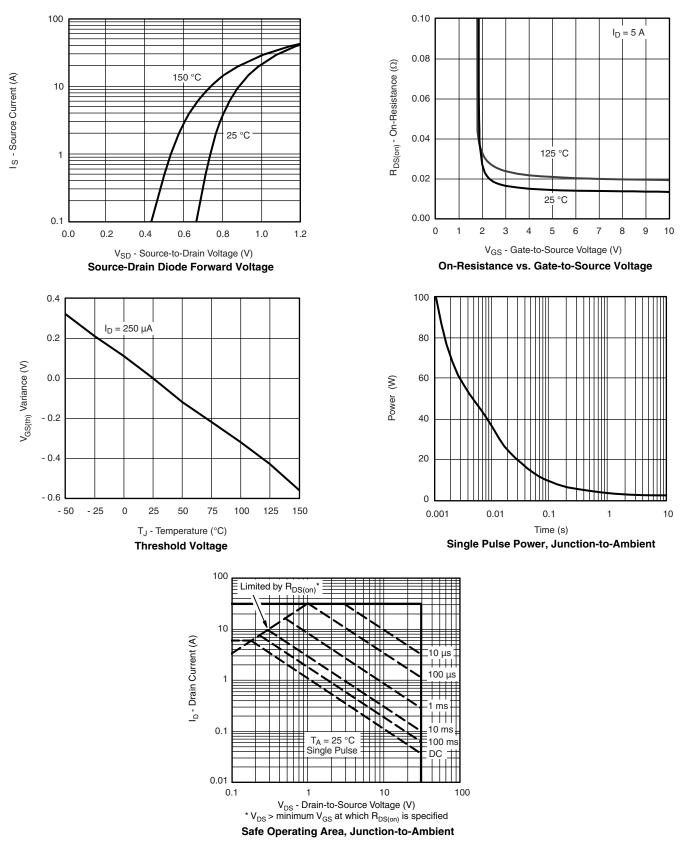








#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

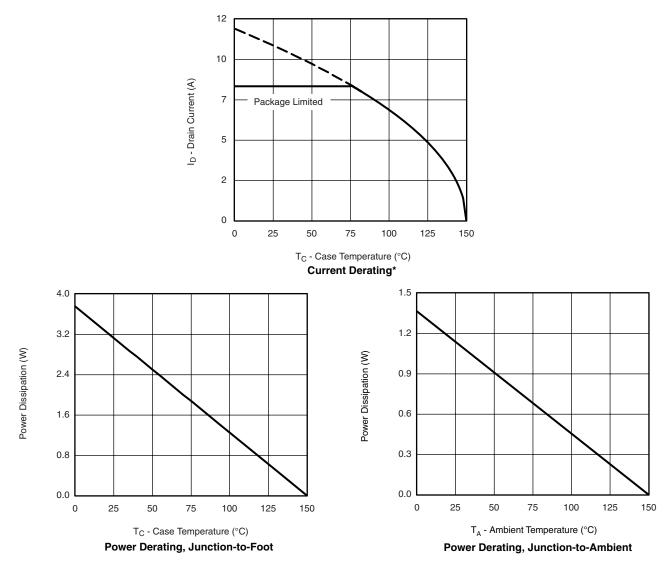




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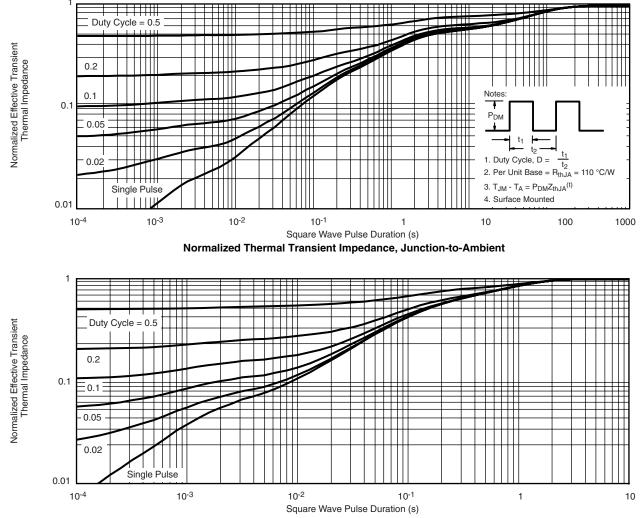
**VISHAY** 



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150 \text{ °C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?74459">www.vishay.com/ppg?74459</a>.



## Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

## **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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